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Field Device Integration (FDI) - Part 101-2: Profiles - Foundation Fieldbus HSE

Táto norma obsahuje anglickú verziu európskej normy.  
This standard includes the English version of the European Standard.

Táto norma bola oznámená vo Vestníku ÚNMS SR č. 11/15

Obsahuje: EN 62769-101-2:2015, IEC 62769-101-2:2015

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Úrad pre normalizáciu, metrológiu a skúšobníctvo SR, 2015  
Podľa zákona č. 264/1999 Z. z. v znení neskorších predpisov sa môžu slovenské technické normy rozmnožovať a rozširovať iba so súhlasom Úradu pre normalizáciu, metrológiu a skúšobníctvo SR.

EUROPEAN STANDARD

**EN 62769-101-2**

NORME EUROPÉENNE

EUROPÄISCHE NORM

July 2015

ICS 25.040.40; 35.100

English Version

**Field Device Integration (FDI) - Part 101-2: Profiles - Foundation  
Fieldbus HSE  
(IEC 62769-101-2:2015)**

Intégration des appareils de terrain (FDI) - Partie 101-2:  
Profils - Foundation Fieldbus HSE  
(IEC 62769-101-2:2015)

Feldgeräteintegration (FDI) - Profile - Teil 101-2:  
Foundation Fieldbus HSE  
(IEC 62769-101-2:2015)

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Comité Européen de Normalisation Electrotechnique  
Europäisches Komitee für Elektrotechnische Normung

**CEN-CENELEC Management Centre: Avenue Marnix 17, B-1000 Brussels**

## Foreword

The text of document 65E/353/CDV, future edition 1 of IEC 62769-101-2, prepared by SC 65E "Devices and integration in enterprise systems", of IEC/TC 65 "Industrial-process measurement, control and automation" was submitted to the IEC-CENELEC parallel vote and approved by CENELEC as EN 62769-101-2:2015.

The following dates are fixed:

- latest date by which the document has to be implemented at national level by publication of an identical national standard or by endorsement (dop) 2016-03-23
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## Annex ZA (normative)

### Normative references to international publications with their corresponding European publications

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE 1 When an International Publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

NOTE 2 Up-to-date information on the latest versions of the European Standards listed in this annex is available here: [www.cenelec.eu](http://www.cenelec.eu).

<u>Publication</u>	<u>Year</u>	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
IEC 61784-1	-	Industrial communication networks Profiles -- Part 1: Fieldbus profiles	-EN 61784-1	-
IEC 61784-2	-	Industrial communication networks Profiles - Part 2: Additional fieldbus profiles for real-time networks based on ISO/IEC 8802-3	-EN 61784-2	-
IEC 61804	series	Function Blocks (FB) for process control	EN 61804	series
IEC 62541-100	2015	OPC unified architecture - Part 100: Device Interface	EN 62541-100	2015
IEC 62769-2	-	Field Device Integration (FDI) - Part 2: FDI-Client		-
IEC 62769-3	-	Field Device Integration (FDI) - Part 3: FDI-Server		-
IEC 62769-4	-	Field Device Integration (FDI) - Part 4: FDI-Packages		-
IEC 62769-5	-	Field Device Integration (FDI) - Part 5: FDI-Information Model		-
IEC 62769-6	-	Field Device Integration (FDI) - Part 6: FDI-Technology Mapping		-
IEC 62769-7	-	Field Device Integration (FDI) - Part 7: FDI-Communication Devices		-
IEC 62769-101-1	-	Field Device Integration (FDI) - Part 101-1:- Profiles - Foundation Fieldbus H1		-



# INTERNATIONAL STANDARD

# NORME INTERNATIONALE

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**Field Device Integration (FDI) –  
Part 101-2: Profiles – Foundation Fieldbus HSE**

**Intégration des appareils de terrain (FDI) –  
Partie 101-2: Profils – Foundation Fieldbus HSE**





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# INTERNATIONAL STANDARD

# NORME INTERNATIONALE

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**Field Device Integration (FDI) –  
Part 101-2: Profiles – Foundation Fieldbus HSE**

**Intégration des appareils de terrain (FDI) –  
Partie 101-2: Profils – Foundation Fieldbus HSE**

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## CONTENTS

FOREWORD .....	4
INTRODUCTION .....	6
1 Scope .....	7
2 Normative references .....	7
3 Terms, definitions, abbreviated terms and acronyms .....	8
3.1 Terms and definitions .....	8
3.2 Abbreviated terms and acronyms .....	8
4 Conventions .....	8
4.1 EDDL syntax .....	8
4.2 XML syntax .....	8
5 Profile for CP 1/2 (FOUNDATION™ HSE) .....	8
5.1 General .....	8
5.2 Catalog profile .....	8
5.2.1 Protocol support files .....	8
5.2.2 CommunicationProfile definition .....	9
5.2.3 Profile device .....	9
5.2.4 Protocol version information .....	9
5.3 Associating a Package with a CP 1/2 device .....	9
5.3.1 Device type identification mapping .....	9
5.3.2 Device type revision mapping .....	10
5.4 Information Model mapping .....	10
5.4.1 ProtocolType definition .....	10
5.4.2 DeviceType mapping .....	10
5.4.3 FunctionalGroup Identification definition .....	10
5.4.4 BlockType property mapping .....	11
5.4.5 Mapping to Block ParameterSet .....	11
5.5 Topology elements .....	11
5.5.1 ConnectionPoint definition .....	11
5.5.2 Communication Device definition .....	13
5.5.3 Communication service provider definition .....	14
5.5.4 Network definition .....	15
5.6 Methods .....	15
5.6.1 Methods for FDI Communication Servers .....	15
5.6.2 Methods for Gateways .....	22
Annex A (normative) Topology scan schema .....	23
A.1 General .....	23
A.2 Network .....	23
A.3 FoundationHSEAddressT .....	23
A.4 FoundationHSEConnectionPointT .....	23
A.5 FoundationHSENetworkT .....	24
A.6 FoundationBlockIdentificationT .....	24
A.7 FoundationIdentificationT .....	25
Annex B (normative) Transfer service parameters .....	27
Annex C (informative) Communication service arguments for Transfer Method .....	28
Bibliography .....	29



Table 1 – Capability File part .....	9
Table 2 – CommunicationProfile definition .....	9
Table 3 – Device type catalog mapping .....	9
Table 4 – ProtocolType Foundation_HSE definition .....	10
Table 5 – Inherited DeviceType property mapping .....	10
Table 6 – Identification parameters .....	11
Table 7 – Inherited BlockType property mapping .....	11
Table 8 – ConnectionPointType ConnectionPoint_Foundation_HSE definition .....	12
Table 9 – Communication device ParameterSet definition .....	14
Table 10 – Method Connect arguments .....	16
Table 11 – Method Disconnect arguments .....	17
Table 12 – Method Transfer arguments .....	18
Table 13 – Method GetPublishedData arguments .....	20
Table 14 – Method SetAddress arguments .....	21
Table A.1 – Attributes of FoundationHSEConnectionPointT .....	24
Table A.2 – Elements of FoundationHSEConnectionPointT .....	24
Table A.3 – Elements of FoundationHSENetworkT .....	24
Table A.4 – Attributes of FoundationBlockIdentificationT .....	25
Table A.5 – Attributes of FoundationIdentificationT .....	26

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International Standard IEC 62769-101-2 has been prepared by subcommittee 65E: Devices and integration in enterprise systems, of IEC technical committee 65: Industrial-process measurement, control and automation.

The text of this standard is based on the following documents:

CDV	Report on voting
65E/353/CDV	65E/416/RVD

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts in the IEC 62769 series, published under the general title *Field Device Integration (FDI)*, can be found on the IEC website.

The committee has decided that the contents of this publication will remain unchanged until the stability date indicated on the IEC website under "<http://webstore.iec.ch>" in the data related to the specific publication. At this date, the publication will be

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## INTRODUCTION

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- b) Method and device for accessing a functional module of automation system, see Patent Family EP2182418;
- c) Methods and apparatus to reduce memory requirements for process control system software applications, see Patent Family US2013232186 ;
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## **FIELD DEVICE INTEGRATION (FDI) – Part 101-2: Profiles – Foundation Fieldbus HSE**

### **1 Scope**

This part of IEC 62769 specifies the IEC 62769 profile for IEC 61784-1, CP 1/2 (FOUNDATION™ Fieldbus HSE)<sup>1</sup>.

### **2 Normative references**

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 61784-1, *Industrial communication networks - Profiles - Part 1: Fieldbus profiles*

IEC 61784-2, *Industrial communication networks - Profiles - Part 2: Additional fieldbus profiles for real-time networks based on ISO/IEC 8802-3*

IEC 61804 (all parts), *Function blocks (FB) for process control*

IEC 62541-100:2015, *OPC Unified Architecture – Part 100: Device interface*

IEC 62769-2, *Field Device Integration (FDI) – Part 2: FDI Client*

NOTE IEC 62769-2 is technically identical to FDI-2022.

IEC 62769-3, *Field Device Integration (FDI) – Part 3: FDI Server*

NOTE IEC 62769-3 is technically identical to FDI-2023.

IEC 62769-4, *Field Device Integration (FDI) –Part 4: FDI Packages*

NOTE IEC 62769-4 is technical identically to FDI-2024.

IEC 62769-5, *Field Device Integration (FDI) – Part 5: FDI Information Model*

NOTE IEC 62769-5 is technical identically to FDI-2025.

IEC 62769-6, *Field Device Integration (FDI) – Part 6: FDI Technology Mapping*

NOTE IEC 62769-6 is technical identically to FDI-2026.

IEC 62769-7, *Field Device Integration (FDI) – Part 7: FDI Communication Devices*

NOTE IEC 62769-7 is technical identically to FDI-2027.

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<sup>1</sup> FOUNDATION™ Fieldbus is the trade name of the non-profit consortium Fieldbus Foundation. This information is given for the convenience of users of this technical report and does not constitute an endorsement by IEC of the trademark holder or any of its products. Compliance does not require use of the trade name. Use of the trade name requires permission of the trade name holder.

IEC 62769-101-1, *Field Device Integration (FDI) – Part 101-1: Profiles – Foundation Fieldbus H1*

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